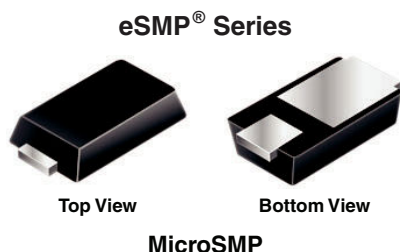




Surface Mount Ultrafast Rectifiers



PRIMARY CHARACTERISTICS

$I_{F(AV)}$	1.0 A
V_{RRM}	100 V, 150 V, 200 V
I_{FSM}	10 A
t_{rr}	25 ns
V_F at $I_F = 1.0$ A	0.82 V
I_R	1 μ A
T_J max.	175 °C

TYPICAL APPLICATIONS

For use in secondary rectification and freewheeling for ultrafast switching speeds AC/AC and DC/DC converters.

FEATURES

- Very low profile - typical height of 0.65 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low power losses
- Ultrafast recovery times for high frequency
- Meets MSL level 1, per J-STD-020C, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

AUTOMOTIVE
GRADE
Available



RoHS
COMPLIANT
HALOGEN
FREE

MECHANICAL DATA

Case: MicroSMP

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS compliant, and automotive grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

PARAMETER	SYMBOL	MUH1PB	MUH1PC	MUH1PD	UNIT
Device marking code		HB	HC	HD	
Maximum repetitive peak reverse voltage	V_{RRM}	100	150	200	V
Maximum average forward rectified current (fig. 1)	$I_{F(AV)}$	1.0			A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	10			A
Operating junction and storage temperature range	T_J, T_{STG}	- 55 to + 175			°C

MUH1PB thru MUH1PD

Vishay General Semiconductor



ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Maximum instantaneous forward voltage	I _F = 0.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.90	-	V
	I _F = 1.0 A			1.0	1.05	
	I _F = 0.5 A	T _A = 125 °C		0.72	-	
	I _F = 1.0 A			0.82	0.90	
Maximum reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	1.0	μA
		T _A = 125 °C		3.0	15	
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A	T _A = 25 °C	t _{rr}	19	25	ns
Typical reverse recovery time	I _F = 1.0 A, dI/dt = 50 A/μs, V _R = 30 V, I _{rr} = 0.1 I _{RM}			29	40	
Typical softness factor (t _b /t _a)	I _F = 1.0 A, dI/dt = 200 A/μs, V _R = 200 V	T _A = 125 °C	S	0.5	-	
Typical reverse recovery current			I _{RM}	3.4	4.6	A
Typical stored charge			Q _{rr}	45	-	nC
Typical junction capacitance	4.0 V, 1 MHz		C _J	10	-	pF

Notes

(1) Pulse test: 300 μs pulse width, 1 % duty cycle(2) Pulse test: Pulse width $\leq 40\text{ ms}$

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	MUH1PB	MUH1PC	MUH1PD	UNIT
Typical thermal resistance	R _{θJA} ⁽¹⁾	166			°C/W
	R _{θJM} ⁽¹⁾	40			

Note

(1) Free air, mounted on recommended copper pad area. Thermal resistance $R_{\theta JA}$ - from junction to ambient, $R_{\theta JM}$ - and junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
MUH1PD-M3/89A	0.006	89A	4500	7" diameter plastic tape and reel
MUH1PDHM3/89A ⁽¹⁾	0.006	89A	4500	7" diameter plastic tape and reel

Note

(1) Automotive grade

RATINGS AND CHARACTERISTICS CURVES

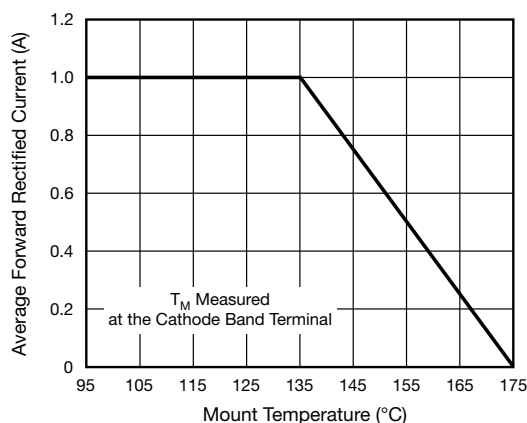
 $(T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

Fig. 1 - Maximum Forward Current Derating Curve

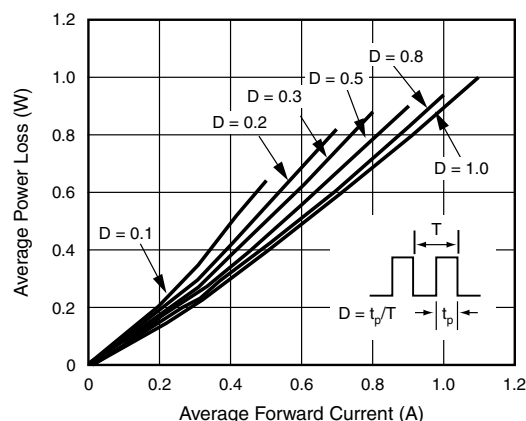


Fig. 2 - Forward Power Loss Characteristics

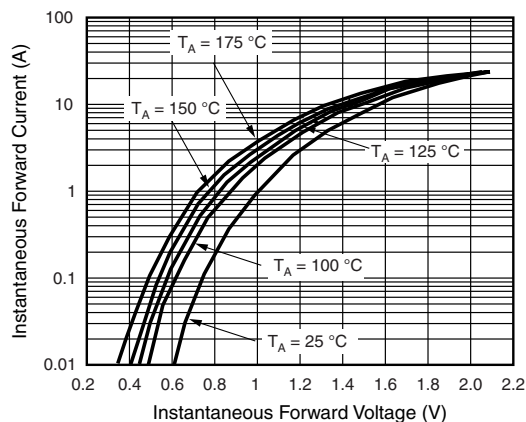


Fig. 3 - Typical Instantaneous Forward Characteristics

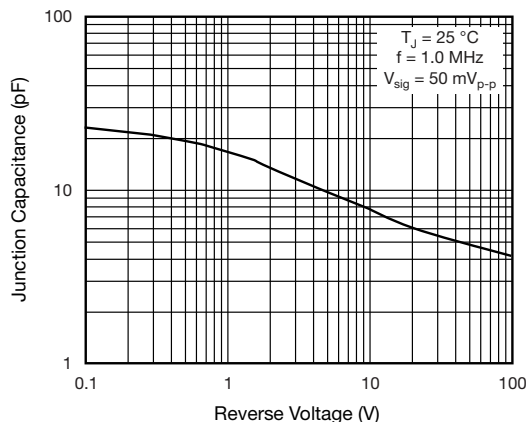


Fig. 5 - Typical Junction Capacitance

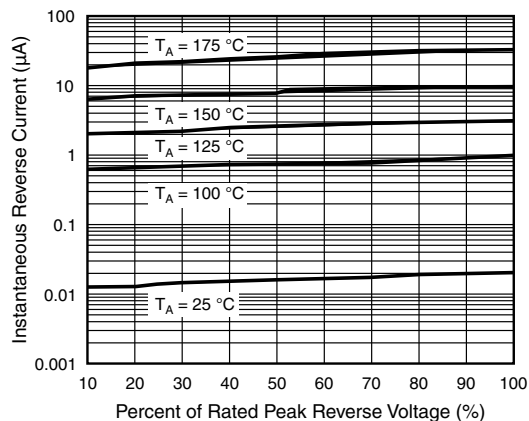


Fig. 4 - Typical Reverse Characteristics

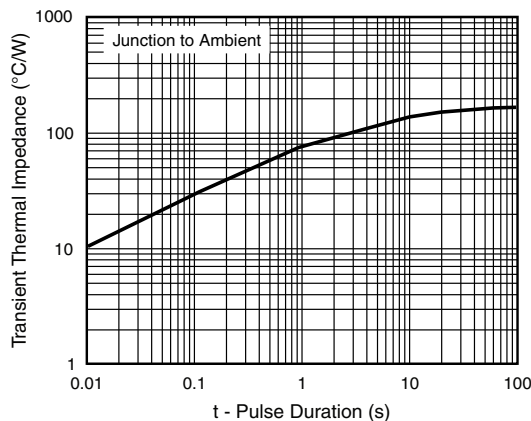
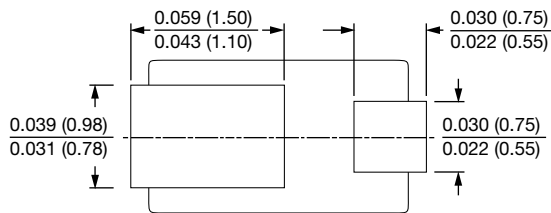
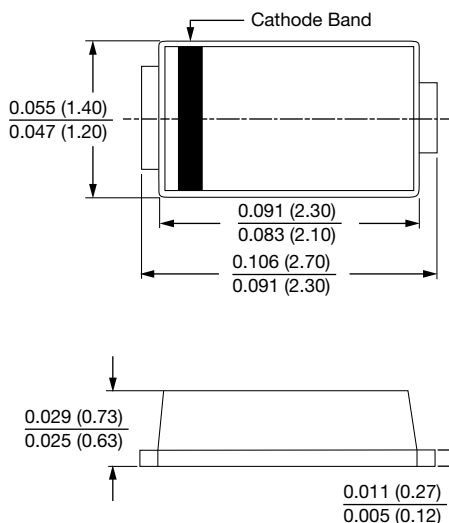


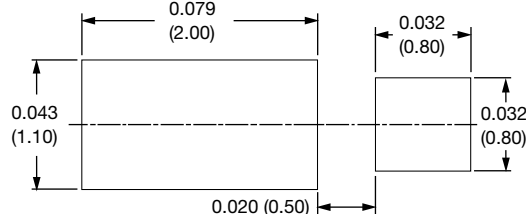
Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

MicroSMP



Mounting Pad Layout





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